

# Programmable resolution 1-wire digital thermometer



#### **PRODUCTS FEATURES**

- Operating voltage: 3.0 V 5.5 V
- Operating current: 38uA during temperature conversion
- Average consumption current: 1.5uA with reading once temperature per second
- Standby current: 100nA, 1000nA
- Temperature conversion time: 30ms at 9-bit
- Temperature accuracy without calibration: ± 0.5 °C. From -10°C to 80°C
- 9 bit ADC for 0.5°C resolution
- Compatible with 1-wire interface
- Temperature range: -50°C to 125°C
- Package: TO-92



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#### 1. Electrical characteristics

Test conditions: Vcc = 3.3V to 5.0V,  $T_A$  = 25°C unless otherwise specified. All limits are 100% tested at  $T_A$  = 25°C

| Parameter                             | Symbol                            | Test Conditions                                | Min                      | Тур  | Max         | Unit |
|---------------------------------------|-----------------------------------|--|--------------------------|------|-------------|------|
| Supply Voltage                        | Vcc                               |  | 3.0                      |      | 5.5         | V    |
|                                       |                                   | VCC = 3.3-5.0V, T <sub>A</sub> =-10°C to 80°C  | -0.5                     |      | 0.5         | °C   |
| Temperature Accuracy                  | T <sub>AC</sub>                   | VCC = 3.0-5.5V, T <sub>A</sub> =-50°C to 125°C | -1.5                     |      | 1.5         | °C   |
| Temperature                           |                                   | 9-bit ADC                                      |                          | 0.5  |             | °C   |
| Resolution                            |                                   |  |                          |      |             |      |
| Operating Current                     | loc                               | during Temperature conversion                  |                          | 38   |             | uA   |
| Average Consumption<br>Current        | IAC                               | Once time T-conversion per second              |                          | 1.5  |             | uA   |
| Shutdown Current                      | Ishutdown                         | Idle, not temperature conversion               |                          | 100  | 1000        | nA   |
| Conversion time                       | tcon                              | From active to finish completely               |                          | 30   |             | ms   |
|                                       |                                   | Digital Interface                              |                          |      |             |      |
| Logic Input Capacitano                | ce C <sub>IL</sub>                | I/O pin  |                          | 20   |             | pF   |
| Logic Input High Voltage              | де Vін                            | I/O pin  | 0.7*VCC                  |      | VCC         | V    |
| Logic Input Low Voltage               | ge V <sub>IL</sub>                | I/O pin  | 0                        |      | 0.2*VC<br>C | V    |
| Logic Input Current                   | I <sub>INL</sub>                  | I/O pin  | -2.0                     |      | 2.0         | uA   |
|                                       |                                   | Communication Timing                           |                          |      |             |      |
| Single-Wire<br>Communication Clock    | T <sub>CLK</sub>                  |  |                          | 15   |             | us   |
| Recovery time                         | trec                              |  | 3.0                      |      |             | us   |
| Time slot for "0" or "1               |                                   |  | 4*T+<br>t <sub>REC</sub> |      |             | us   |
| Device Reset Low Tim                  | e treset                          |  |                          | 32*T |             | us   |
| Device Reset High<br>Response Time    | t <sub>PDH</sub>                  |  |                          | 2*T  |             | us   |
| Response Time                         | Device Reset Low<br>Response Time |  |                          | 8*T  |             | us   |
| Device Reset Respons<br>Sampling Time | se t <sub>HSP</sub>               |  | 2*T                      |      | 10*T        | us   |
| Write '0' Low Time'                   | twoL                              |  | 4*T                      |      | 8*T         | us   |
| Write '1' Low Time'                   | t <sub>W1L</sub>                  |  | 2.0                      |      | 1*T         | us   |
| Read bit Low Time                     | t <sub>RL</sub>                   |  | 2.5                      |      | 1*T         | us   |
| Read bit sampling Tim                 | ie thsk                           |  | tRL                      |      | 2*T         | us   |



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- \* Note for electrical characteristics:
- 1) All devices are 100% production tested at  $T_A = 25$ °C, all specifications over such temperature range is guaranteed by design, not productions tested.
- 2) For copy TH, TL[0X48] operation, the minimum voltage should be ever 4.0V

### 2. Absolute maximum ratings

| Parameter                                | Symbol                 | Value       | Unit |
|--|------------------------|-------------|------|
| Supply Voltage                           | V <sub>CC</sub> to GND | -0.3 to 5.5 | V    |
| I/O pin Voltage                          | V <sub>IO</sub> to GND | -0.3 to 5.5 | V    |
| Operation junction temperature           | TJ                     | -50 to 150  | °C   |
| Storage temperature Range                | T <sub>STG</sub>       | -65 to 150  | °C   |
| Lead Temperature (Soldering, 10 Seconds) | T <sub>LEAD</sub>      | 260         | °C   |
| ESD MM                                   | ESD <sub>MM</sub>      | 600         | V    |
| ESD HBM                                  | ESD <sub>HBM</sub>     | 6000        | V    |
| ESD CDM                                  | ESD <sub>CDM</sub>     | 1000        | V    |

#### Recommended operating conditions

| Parameter                           | Symbol          | Value      | Unit |
|-------------------------------------|-----------------|------------|------|
| Supply Voltage                      | V <sub>CC</sub> | 3.0 ~ 5.5  | V    |
| Ambient Operation Temperature Range | T <sub>A</sub>  | -50 ~ +125 | °C   |

<sup>\*</sup> Note for absolute maximum ratings:

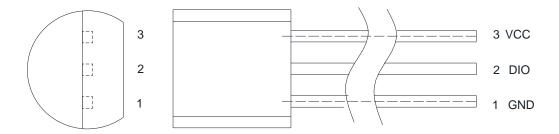
2) Using 2oz dual layer (Top, bottom) FR4 PCB with 4x4mm² cooper as thermal PAD

<sup>1)</sup> Stresses greater than those listed under "Absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at the "Absolute maximum Ratings" conditions or any other conditions beyond those indicated under "Recommended operating conditions" is not recommended. Exposure to "Absolute Maximum ratings" for extended periods may affect device reliability.

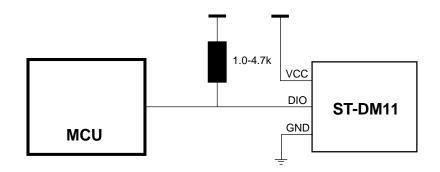


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# 3. Pin configurations



# 4. Typical application

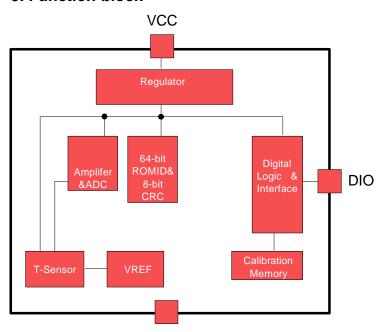


| PIN № | PIN Name | Description  |
|-------|----------|--|
| GND   | 1        | Ground pin   |
| DIO   | 2        | Digital interface data input and output pin, generally it needs a pull-up resistor to VCC in most application, between 1.0k and 4.7k |
| VCC   | 3        | Power supply input pin, it should connect a 100nF to 1.0uF ceramic cap at least to ground  |



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#### 5. Function block



## 6. Protocol operating diagram

| Part 1  | Part 2   | Part 3   |
|---|--|--|
| Reset   | ROM Function Command and/or Device Function Command                  | Data Tx/Rx   |
| 1. Device Reset  Pull-low I/O pin with 450us to 650 us duration | 1. ROM Function command, including :       0x33         2) Match ROM | Including 1. Read data from the chip, or 2. Write data into register |

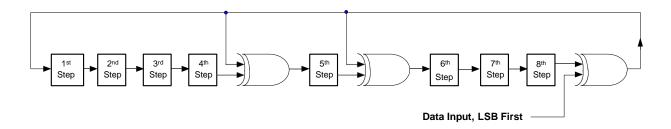


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#### 64-bit ROM ID Definition

| 8 bits  |     |  | 48 bits | 8 bits |  |     |  |
|---|-----|--|---------|--------|--|-----|--|
| CRC Code<br>[X <sup>8</sup> +X <sup>5</sup> +X <sup>4</sup> +1] |     | Serial number<br>[48-bit, factory trimmed] |         |        |  |     |  |
| MSB   | LSB | MSB  | LSB     | MSB    |  | LSB |  |

# 8-bit CRC Code generator diagram



## Register map

| Byte    | *Attribution | R        | Default                         |       |
|---------|--------------|----------|---------------------------------|-------|
| Address |              | Name     | Description                     | value |
| 0x00    | R/O          | TLSB     | Temperature data, LSB Byte      | 0xAA  |
| 0x01    | R/O          | TMSB     | Temperature data, MSB Byte      | 0x00  |
| 0x02    | R/W          | тн       | Upper Alarm trigger temperature | 0xFF  |
| 0x03    | R/W          | TL       | Lower Alarm trigger temperature | 0XFF  |
| 0x04    | R/W          | CONFIG   | *Configuration register         | 0X7F  |
| 0x05    | R/O          | Reserved | Reserved Byte 0                 | N/A   |
| 0x06    | R/O          | Reserved | Reserved Byte 1                 | N/A   |
| 0x07    | R/O          | Reserved | Reserved byte 2                 | N/A   |
| 0x08    | R/O          | CRC      | CRC code byte (8-bit)           | N/A   |



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#### \*Note:

- 1. These registers data can be changed by writing Register command, after power on reset, the data will reload from memory.
- 2. In Attribution column, R/O means read only; R/W means readable/writable
- 3. For CONFIG register, all R/W bits are reserved for testing, DO NOT write any data into these bits.

### 7. Function descriptions

The chip can sense temperature and convert it into digital data by a 9-bit ADC. Also the chip supports user-programmable upper/lower trigger temperature settings. Single-Wire interface is compatible with 1-wire and the protocol shown in Figure-3. Generally, one complete communication with host, like MCU, should include Part1, Part2 and Part3. For Search ROM, it is an exception. The device supports 5 ROM function commands and 6 Device Function commands. First, the host issues above ROM function commands; then completion, the chip can be accessed via above Device function after successful commands by the host. SST-DM11 can be powered by the local power supply; it can also be powered from the communication line, which is called parasitic power supply. It is recommended to force power supply pin at VCC pin for high precision temperature application. The chip has 8 registers; the register address is from 0x00 to 0x07. And each register has 8-bits, 1-byte. The last byte, 9th-byte is CRC code generated by above 8 bytes register data. The detail information is shown in "Register map". All registers data can be read out by read register command, 0xBE. TH, TL and CONFIG register can be written by write register command, 0x4E

#### 7.1 Temperature Data [Byte Add: 0x00, 0x01]

The major function of the chip is to measure temperature. The A-to-D converter resolution of the sensor is 9 bit, corresponding to  $0.5^{\circ}$ C. The SST-DM11 powers up in a low-power idle state. To initiate a temperature measurement and A-to-D conversion, the host has to issue a Temperature Conversion command [0x44h]. After the conversion, the temperature data is stored in the 2-byte temperature register, TLSB [0x00] and TMSB [0x01], and then the chip returns to idle state. The temperature data is stored in the temperature register as a 9-bit sign- extended two's complement format in degrees Celsius. It is composed by 8 'S' bits (signature) and 8 'DATA' bits. The signature bits(S) indicate if the temperature is positive or negative: for positive numbers S = 0 and for negative numbers S = 1. The 'DATA' bits express the temperature in Celsius degree directly, and the resolution is  $0.5^{\circ}$ C, and the expressed range is from -127°C to +127°C.



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The maximum operation temperature range of the chip is -50°C to +125°C, since the chip is based on semiconductor process and material. The default temperature data is 85°C after power-on reset. Below tables show the examples of digital output data and the corresponding temperature (°C).

# 16-bit temperature data format [MSB, LSB]

| Temperature (°C) | 16-bit Digital Output (HEX) | 16-bit Digital Output (BIN) |
|------------------|-----------------------------|-----------------------------|
| +127.5           | 0x00FF                      | 0000, 0000, 1111, 1111      |
| +125.0           | 0x00FA                      | 0000, 0000, 1111, 1010      |
| +85.5            | 0x00AB                      | 0000, 0000, 1010, 1011      |
| +25.0            | 0x0032                      | 0000, 0000, 0011, 0010      |
| +10.5            | 0x0015                      | 0000, 0000, 0001, 0101      |
| +0.5             | 0x0001                      | 0000, 0000, 0000, 0001      |
| 0.0              | 0x0000                      | 0000, 0000, 0000, 0000      |
| -0.5             | 0xFFFF                      | 1111, 1111, 1111, 1111      |
| -10.0            | 0xFFEC                      | 1111, 1111, 1110, 1100      |
| -25.0            | 0xFFCE                      | 1111, 1111, 1100, 1110      |
| -50.0            | 0xFF9C                      | 1111, 1111, 1001, 1100      |

### Temperature data in register

| ·                     | Byte<br>Address | Bit7           | Bit6           | Bit5           | Bit4 | Bit3           | Bit2           | Bit1 | Bit0            |
|-----------------------|-----------------|----------------|----------------|----------------|------|----------------|----------------|------|-----------------|
| LSB                   | 0x00            | <sub>2</sub> 6 | <sub>2</sub> 5 | <sub>2</sub> 4 | 23   | <sub>2</sub> 2 | <sub>2</sub> 1 | 20   | <sub>2</sub> -1 |
| Celsius<br>degree[°C] |                 | 64             | 32             | 16             | 8    | 4              | 2              | 1    | 0.5             |
| MSB                   | 0x01            | S              | S              | S              | S    | S              | S              | S    | S               |
| Celsius<br>degree[°C] |                 | sign           | Sign           | sign           | sign | sign           | sign           | Sign | sign            |



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### 7.2 Temperature Alarm Setup, TH & TL [Byte Add: 0x02, 0x03]

Temperature conversion results will be automatically compared with the temperature alarm value setup by user to determine whether there is an alarm condition. Alarm threshold also uses 2's complement format with 8-bit (1 bit sign, S + 7 bits data). Alarm temperature is set to 1°C increments with 1-byte shown as below table. If the temperature conversion result is greater than or equal to TH value or less than the TL value, it will generate an alarm flag on single-wire bus. After a temperature alarm, the device will respond with a Search Temperature Alarm ROM ID command, 0xEC. If the result of the subsequent temperature conversion value is within the TH and TL defined range, the alarm condition is removed. The TH and TL registers data are stored with nonvolatile Memory, so they will retain data when the device is powered down. Also TH and TL can be accessed and changed using read or write register command. However TH and TL data are loaded from memory every time after power on reset or using recall memory command, 0xB8. For threshold temperature of TH, TL, the format is shown as below table.

|                      | Byte<br>Address | Bit7 | Bit6           | Bit5           | Bit4           | Bit3           | Bit2                  | Bit1           | Bit0           |
|----------------------|-----------------|------|----------------|----------------|----------------|----------------|-----------------------|----------------|----------------|
| TH                   | 0x02            | S    | 2 <sup>6</sup> | 2 <sup>5</sup> | 2 <sup>4</sup> | 2 <sup>3</sup> | <b>2</b> <sup>2</sup> | 2 <sup>1</sup> | 2 <sup>0</sup> |
| Celsius degree[°C]   |                 | sign | 64             | 32             | 16             | 8              | 4                     | 2              | 1              |
| Default [0x55, 85°C] |                 | 0    | 1              | 0              | 1              | 0              | 1                     | 0              | 1              |
| TL                   | 0x03            | S    | 2 <sup>6</sup> | 2 <sup>5</sup> | 2 <sup>4</sup> | 2 <sup>3</sup> | <b>2</b> <sup>2</sup> | 2 <sup>1</sup> | 2 <sup>0</sup> |
| Celsius degree[°C]   |                 | sign | 64             | 32             | 16             | 8              | 4                     | 2              | 1              |
| Default [0x00, 0°C]  |                 | 0    | 0              | 0              | 0              | 0              | 0                     | 0              | 0              |

### 7.3 Config Register [Byte Add: 0x04]

The chip has a 8-bit (1-Bytes) configuration register, bit0, bit1, bit2 and bit7 are readable/writable attribution for user. All 4 bits is reserved for testing and do not write any data into this register via write register command, 0x4E. Also user can read out register data. And the register will reset to default data after power-up. 8 bits definition is shown as below table.

### Config Register definition

| Byte Add,<br>0x04 | bit7     | bit6 | bit5 | bit4     | bit3 | bit2     | bit1     | bit0     |
|-------------------|----------|------|------|----------|------|----------|----------|----------|
| Definition        | Reserved | N/A  | N/A  | Reserved | N/A  | Reserved | Reserved | Reserved |
| Attribution       | R/W      | R/O  | R/O  | R/O      | R/O  | R/W      | R/W      | R/W      |
| Default, 0x7F     | 0        | 1    | 1    | 1        | 1    | 1        | 1        | 1        |



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#### 8. ROM function command

After the host detects a presence pulse, it can issue a ROM function command. These commands are related to each device's unique 64-Bit ROM ID code, allowing multiple Single-Wire devices connected on a single bus line and operated accordingly. These commands also allow the host to detect the number of Single-Wire devices and the types, and whether a device is in the alarm state. Each device supports basic 8 kinds ROM command, each command code length is 8-bit. Before Device Function commands are issued, the host must submit the appropriate ROM Function command. ROM Function command operation flowchart is shown in application note. And there is a brief description for each ROM Function command and the usage.

### 8.1 Read ROM [0x33]

This ROM command only applies to one device on Single-Wire bus. It allows the host to read directly the device's 64-Bit ROM ID code without performing a search ROM. If the command is used for multi-node connections, data conflict is inevitable because each device will respond to this command at same time.

## 8.2 Match ROM [0x55]

This command is followed by 64-ROM ID allowing the host to access a specified Single-Wire device in multi-node connections. Only when the slave device completely matches 64-Bit ROM ID, it will respond to the function command that host issued; all other devices will wait for a reset pulse.

# 8.3 Search ROM [0xF0]

When the system powers up, the host must identify all Single-Wire devices' ROM ID codes on the bus. And therefore the host can determine the number and the type of devices. By repeatedly performing a Search ROM command (Search ROM command followed by bits of data exchange), the host identifies all Single-Wire devices on the bus. If the bus has only one device, you can use the read ROM command to replace Search ROM command. After completion of each ROM search, the host must return to the first step in the command sequence (initialization).

# 8.4 Skip ROM [0xCC]

In a single-node application, the host can use this command to quickly access the device on the bus without issuing identical ROM ID code information, which saves corresponding time instead of sending the 64-Bit ROM ID. However in a multi-node application, if the host wants all devices on the bus to perform the same subsequent function command, the host can also use the Skip ROM command. For example, the host issues a Skip ROM command before a Temperature Conversion [0x44] command; then all the SST-DM11 devices on the same bus will begin the temperature conversion simultaneously. In this way it saves time for performing the entire temperature measurements and gets the temperature conversion results simultaneously.



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This example is particularly useful for the analysis of temperature fields. Please note, if user issue a Skip ROM command followed by a Read Register [0xBE] command (including other read command), this command can only be applied to a single node system; otherwise multiple nodes will respond to the command and therefore cause conflicting communication data.

### 8.4.1 Search Temperature Alarm ROM ID [0xEC]

Only those Single-Wire devices with temperature alarm flag respond to this command. This works exactly the same as the search ROM ID command. This command allows the host to determine which device has generated the temperature alarm In the same way as Search ROM ID command, after the completion of the search cycle, the host must return to the first step in the command sequence.

#### 9. Device Function Command

Device Function command is similar as above ROM Function command and the flowchart describes the implementation of several commands and function command protocol such as read/write Register, start temperature conversion, and read/write memory commands. And there are brief description for each Device Function command and the usage.

## 9.1 Write Register [0x4E]

This command allows the host to write 3-bytes of data into SST-DM11 Register register. The first byte is TH register (byte address 0x02), the second byte the TL register (byte address 0x03), and the third byte the configuration register (byte address 0x04). Data is transmitted starting from the least significant bit. Before the host sends a reset signal, these three bytes must be written, otherwise it may lead to an error of incomplete data transfer.

## 9.2 Read Register [0xBE]

This command allows the host to read the contents of the Register register. Data transmission always starts from byte address 0 (the least significant bit of the temperature register) and continues until finishing the remaining seven bytes of Register. If the host continues to read, it reads the 9th byte, the 8-Bit CRC. The CRC is generated by SST-DM11 using the same polynomial in ROM ID CRC generator. CRC is sent in the original format. If only part of the register data is needed, the host can send a reset signal to end this reading operation.



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### 9.3 Temperature Conversion [0x44]

This command starts the temperature conversion. After the conversion is complete, the measured temperature data will be stored into the registers (byte address, 0x00, 0x01.). SST-DM11 then returns to a low-power idle state. If the device is in "parasitic power mode", the host pulls Single-Wire bus into the strong state (the time value and resolution independent) after sending the command. The host monitors the conversion process in each time slot. When the host reads the logic '1 'instead of '0', it indicates the temperature conversion is complete.

### 9.4 Read Power Mode [0xB4]

When this command is executed, the host will receives 0xFF if the chip is power in normal supply mode (force power at VCC pin), or receives 0x00 if the chip is powered in parasitic mode (VCC pin is short to GND, the chip is powered by DIO pin)

## 9.5 Recall TH, TL [0xB8]

This command will recall the TH and TL alarm values from backup memory, and copy them to the associated registers (Byte add, 0x02 and 0x03). After this command code is sent, the host sends a read time slot to monitor the recall process. When the host reads "1" instead of "0", it indicates that the data read back is complete. When the chip powers up every time, the register data is automatically loaded from the corresponding memory address as default data.

## 9.6 Recall TH, TL [0xB8]

This command copies the register contents of the TH and TL registers Data written by issuing Write Register command [0x4E] into Memory. If the chip is used in parasite power mode, within 10µs (max) after this command is issued the host must switch to a strong pull-up condition on the Single-Wire bus for at least 10ms.

### 10. CRC generator

CRC (Cyclic Redundancy Check) bytes are provided as part of the chip's 64-bit ROM ID code and in the 9<sup>th</sup> byte of the register. For the ROM ID code, CRC part is calculated based the first 56 bits and is contained in the most significant byte of the ROM ID code. The register CRC is calculated from the data stored in the Register, and therefore it changes when the data in the Register changes. The CRCs provide the host with a method of data validation when data is read from the chip. To verify that data has been read correctly, the host must do calculation the CRC based on the received data and then compare this value to either the ROM code CRC (for ROM reads) or to the Register CRC (for Register reads). If the calculated CRC matches the read CRC, the data has been received error free. The comparison of CRC values and the decision to continue with an operation are determined entirely by the host. The equivalent polynomial function of the CRC (ROM or Register) is:

 $CRC = X^8 + X^5 + X^4 + 1$ 



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The host can re-calculate the CRC and compare it to the CRC values from the SST-DM11 using the polynomial generator shown in the section "8-bit CRC Code generator diagram". This circuit consists of a shift register and XOR gates, and the shift register bits are initialized to 0x00. Starting with the least significant bit of the ROM ID code or the least significant bit of byte 0x00 in the Register, one bit at a time should shifted into the shift register. After shifting in the 56th bit from the ROM or the most significant bit of byte 7 from the Register, the polynomial generator will contain the re-calculated CRC. Next, the 8-bit ROM code or Register CRC from the SST-DM11 must be shifted into the circuit. At this point, if the re-calculated CRC was correct, the shift register will contain all 0s. The summarization for the CRC generator is shown as below, which can be used for software reference:

- a) Data input with LSB first
- b) Polynomial is CRC = X8+X5+X4+1
- c) Data movement is left shift
- d) Initial data always is 0x00
- e) Data length is 8-bit

When put CRC data as input the result must be the initial data, 0x00

#### 11. 64-bits ROM ID

Each SST-DM11 contains a unique ROM ID code as serial number. First 8 bits are Single-Wire family code, for this chip, it is 0x28, the next 48 bits are unique serial number, the last 8 bits is the CRC code generated based on previous 56 bits, shown in section "64-bit ROM ID Definition". The shift register is first initialized to 0, then shifts the family code; each time shifted one bit, least significant bit first,. After the 8th bit of family code is shifted, it starts to shift 48 bits serial number. After the last bit of serial number is shifted, the shift register contains the CRC value. After shifting the 8-Bit CRC, all the bits of the shift register are same as initial data, 0x00.



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## 12. Single-Wire bus

Single-Wire bus system consists of a host and one or more salve devices. In any case, SST-DM11 are slave devices. The bus host could be a microcontroller or SoC. Discussion of Single-Wire bus system is divided into three parts: the hardware configuration, the operation sequence and Single-Wire timing.

### 12.1 Hardware Configuration

According to the definition of Single-Wire bus system, it has only one data line physically. In order to facilitate this, each device on the bus needs to have open-drain or tri-state output, and SST-DM11's Single-Wire port (DIO pin) uses an open-drain output. A typical circuit is shown in the section "Typical application". Multi-node system consists of a Single-Wire host and multiple slave devices. SST-DM11 supports around 16kbps (default rate) of fixed and variable communication rate. Pull-up resistor depends primarily on the number of nodes, the communication distance and the line load. For example with the communication distance of less than 20cm, a single node and an independent power supply condition, SST-DM11 requires an external  $4.7k\Omega$  (typical) pull-up resistor. If the communication distance is greater than 30m, you need a 1.0k or smaller pull-up resistor even with single-node and an independent power supply, Single-Wire bus idle state is high. If for some reason the device needs suspend temporally and then return to work, it must be placed on the bus idle state.

### 12.2 Operation Sequence

To access this sensor chip through Single-Wire port, the complete procedure is shown in the section "Protocol operating diagram", it includes:

Part 1: Device Reset, refer to below section for description in detail.

**Part 2:** bus function command, including ROM Function command and Device Function command. In most cases, Device Function command is followed by ROM Function command. Sometimes, ROM Function

command can be used independently without Device Function command, like Search ROM.

**Part3:** Data Receiving/Transmitting, includes receive data from Single-Wire device or send data to Singe- Wire device.

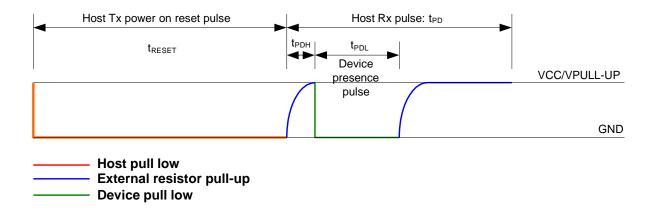


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#### 12.3 Device Reset

When the chip is applied power first time, it will perform internal Device Reset action automatically, reset all registers and configurations as initial state, and recall memory data into register as default. All operations of Single-Wire bus always begin with a Device Reset. Device Reset consists of a reset pulse sent by the host and a device responses pulse shown in below "Device Reset Timing Diagram". The presence pulse is used to notify the host that the chip is already connected on the bus. When a Single-Wire device sends a response pulse to the host, it tells the host that it is on the bus and ready to work. During the initialization process, host pulls the bus low for treset period time, thus produces (Tx) Device Reset pulse. Then, the host releases the bus and goes into receive mode (Rx). When the bus is released, the bus is pulled up by an external pull-up resistor. When a Single-Wire device detects a rising edge, it will remain high for tpdh (2T in typical), then the Single-Wire device generates a presence pulse by pulling the bus low for tPDL (8T in typical). After that the bus is released and pulled back high by the external pull-up resistor, at least keeping the 6T time. Thus, the entire Single-Wire device response cycle is at least tpd (16T in typical). After that, the host can begin to transfer the ROM command. If user needs more precise communication time match, the host can measure the Single-Wire device response tPDL (8T in typical) low pulse, and adjust the time of the original Device Reset pulse, treset, and the read sampling timing. Once the device successfully captures the communicate reset pulse, it will use it to set the communication speed.

#### **Device Reset Timing Diagram**





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### 12.4.1 Single-Wire Timing

After complete reset successfully on Single-Wire bus, the next step is to perform ROM Function command and/or Device Function command. The following section is to descript the bit transmission. All Single-Wire devices require to strictly comply with Single-Wire communication protocol to ensure data integrity. The protocol defines several signal types: power-on reset pulse, communications reset pulse, presence pulse, write "0", write "1", read "0", and read "1". All these signals except presence pulse are synchronous signals issued by the host. And all the commands and data are the low byte first which is different from other serial communication format (high byte first).

During Write Time Slot the host writes data to a Single-Wire device; and during the Read Time Slot, the host reads the data from the Single-Wire device. In each time slot, the bus can only transmit one bit data.

#### 12.4.2 Write Time Slot

There are two write time slot modes: write "1" and write "0" slot. The host writes into Single-Wire device "1" by using a write "1" slot, and host write into Single-Wire device "0" by using write "0". All write time slots are at least tslot (4\*T + trec in typical), and need the recovery time at least 3µs between two separate time slots. Two kinds of write slots start with pull-down bus by the host shown in below Figure. To produce a write "1" slot, the host must release the bus within  $tw_{1L}$  (<= 1\*T) after pulling down for 1us, and then the bus is pulled-up by an external pull-up resistors on the bus. To produce a write "0" slot, after the host is pulling the bus low, it maintains a low level during the entire time slot, that is  $tw_{0L}$  (> = 4T). During the write time slots, Single-Wire device samples bus level status at tsrect (2\*T in typical) time. If sampling results at this time is high, then the logic "1" is written to the device; If "0", the write logic is "0".

#### 12.4.3 Read Time Slot

Single-Wire device can only transmit data to the host after the host issues read time slots. After the host issues a read data command, a read time slot must be generated in order to read data from the Single-

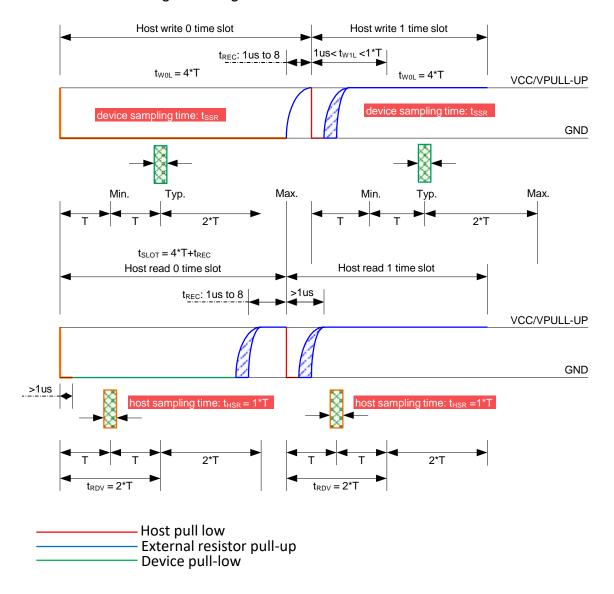
Wire device. A complete read time slot is at least tslot (4\*T + trec), and requires at least 3us recovery time between two separate time slots. Each time slot is generated by the host to initiate the read bit, a low level period is required to be at least 1µs shown in below Figure. Once the device detects a Single-Wire bus low, the device immediately sent bit "0" or "1" on the bus. If Single-Wire device sends "1", the bus is pulled-up



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high by a pull-up resistor after the short low period; if sent "0", then the bus is keeping low for  $t_{DRV}$  (2\*T in typical). After that the device releases the bus from pull-up resistors and back to idle high. Therefore, the data issued by Single-Wire device after read time slot at the beginning stay effective during time  $t_{DRV}$  (2\*T in typical). During the read time slots the host must release the bus, and samples the bus states at 2T after the start of a slot (optimum sampling time point 1T).

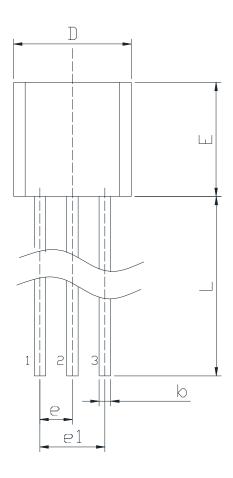
### Read/Write Timing Slot Diagram:

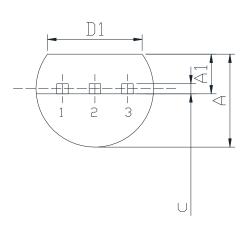




# Programmable resolution 1-wire digital thermometer

# 13. Package Outline Dimensions (TO-92)



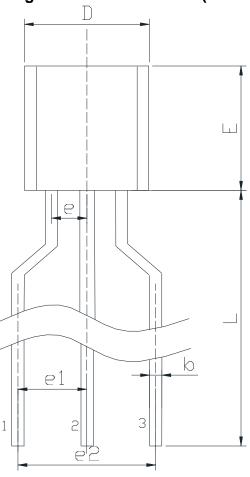


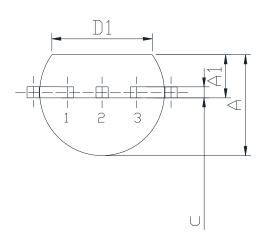
| Symbol | Dimensions in Millimeters |        | Dimensions in Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| Α      | 3.300                     | 3.800  | 0.130                | 0.150 |
| A1     | 1.100                     | 1.400  | 0.043                | 0.055 |
| b      | 0.380                     | 0.550  | 0.015                | 0.022 |
| С      | 0.300                     | 0.510  | 0.012                | 0.020 |
| D      | 4.300                     | 4.700  | 0.169                | 0.185 |
| D1     | 3.430                     |        | 0.014                |       |
| E      | 4.300                     | 4.700  | 0.169                | 0.185 |
| е      | 1.270 (TYP)               |        | 0.050 (TYP)          |       |
| e1     | 2.540 (TYP)               |        | 0.100 (TYP)          |       |
| L      | 13.000                    | 15.000 | 0.512                | 0.590 |



# Programmable resolution 1-wire digital thermometer

# 14. Package Outline Dimensions (TO-92 Bend Lead)



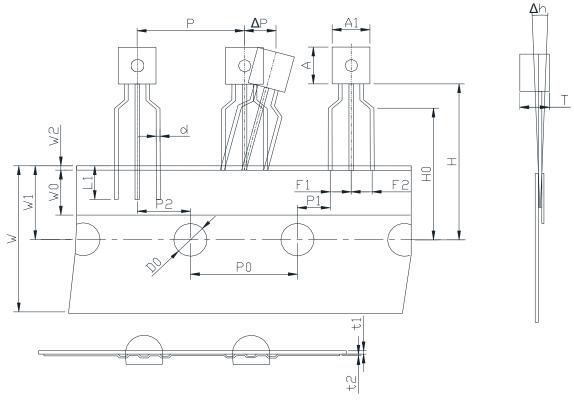


| Symbol | Dimensions in Millimeters |        | Dimensions in Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| Α      | 3.300                     | 3.800  | 0.130                | 0.150 |
| A1     | 1.100                     | 1.400  | 0.043                | 0.055 |
| b      | 0.380                     | 0.550  | 0.015                | 0.022 |
| С      | 0.300                     | 0.510  | 0.012                | 0.020 |
| D      | 4.300                     | 4.700  | 0.169                | 0.185 |
| D1     | 3.430                     |        | 0.014                |       |
| E      | 4.300                     | 4.700  | 0.169                | 0.185 |
| е      | 1.270 (TYP)               |        | 0.050 (TYP)          |       |
| e1     | 2.500 (TYP)               |        | 0.098 (TYP)          |       |
| e2     | 5.000 (TYP)               |        | 0.196 (TYP)          |       |
| L      | 13.000                    | 15.000 | 0.512                | 0.590 |



# Programmable resolution 1-wire digital thermometer

# **AMMO Packing Dimensions (TO-92)**



| Item                            | Symbol | Value &Tolerance |  |
|---------------------------------|--------|------------------|--|
| Body Width                      | A1     | 4.5±0.2          |  |
| Body Height                     | A      | 4.5±0.2          |  |
| Body Thickness                  | Т      | 3.5±0.1          |  |
| Lead Wire Diameter              | d      | 0.46+0.09/-0.08  |  |
| Pitch of Component              | Р      | 12.7±0.3         |  |
| Feed Hole Pitch                 | P0     | 12.7±0.2         |  |
| Hole Center to Component Center | P2     | 6.35±0.3         |  |
| Lead to Lead Distance           | F1,F2  | 2.5±0.3          |  |
| Component Alignment, F-R        | Δh     | 0±1.0            |  |
| Type Width                      | W      | 18.0+1.0/-0.5    |  |
| Hole Down Tape Width            | W0     | 6.0±0.5          |  |



# Programmable resolution 1-wire digital thermometer

| Item                                 | Symbol | Value &Tolerance |
|--------------------------------------|--------|------------------|
| Hole Position                        | W1     | 9.0±0.5          |
| Hole Down Tape Position              | W2     | 1.0MAX           |
| Height of Component From Tape Center | Н      | 19.0+2.0/-1.0    |
| Lead Wire Clinch Height              | H0     | 16.0±0.5         |
| Lead Wire(Tape Portion)              | L1     | 2.5MIN           |
| Feed Hole Diameter                   | D0     | 4.0±0.2          |
| Taped Lead Thickness                 | t1     | 0.4±0.05         |
| Carrier Tape Thickness               | t2     | 0.2±0.05         |
| Position of Hole                     | P1     | 3.85±0.3         |
| Component Alignment                  | ΔΡ     | 0±1.0            |